

NPN COMPLEMENTARY SILICON TRANSISTSOR

CD2383



TO-92 Plastic Package

Vertical Deflection Output and Class B Sound Output Applications of Color T.V

ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	VALUE	UNIT
Collector Emitter Voltage	V _{CEO}	160	V
Collector Base Voltage	V _{CBO}	160	V
Emitter Base Voltage	V _{EBO}	6	V
Collector Current Continuous	I _C	1	A
Base Current Continuous	I _B	500	mA
Power Dissipation	P _D	700	mW
Operating And Storage Junction Temperature Range	T _j , T _{stg}	-55 to +150	٥C

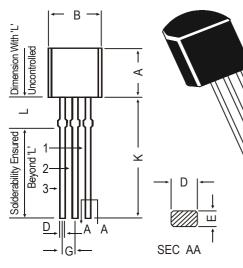
ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)

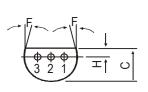
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Collector Emitter Breakdown Voltage	BV_{CEO}	I _C =10mA,I _B =0	160			V
Collector Cut off Current	I _{CBO}	V _{CB} =150V, I _E = 0			1	μA
Emitter Cut off Current	I _{EBO}	$V_{BE} = 6V, I_{C} = 0$			1	μA
DC Current Gain	h _{FE} *	V _{CE} =5V,I _C =200mA	60		320	
Collector Emitter Saturation Voltage	V _{CE(sat)} *	I _C =500mA, I _B =50mA			1.5	V
Base Emitter on Voltage	V _{BE(on)} *	V _{CE} =5V, I _C =5mA	0.45		0.75	V
DYNAMIC CHARACTERISTICS						
Gain Bandwith Product	f _T	I _C =200mA, V _{CE} =5V	20	100		MHz
Output Capacitance	C _{ob}	I _C =0, V _{CB} =10V			20	pF
		f=1MHz				
*Pulse Condition: Width \leq 300ms, Duty	Cycle <u><</u> 2%.					
CLASSIFICATION	R	Ο		Y		

hFE 60-120 100-200 160-320	CLASSIFICATION	ĸ	0	T	
	hFE	00-120	100-200	160-320	

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PIN CONFIGURATION

COLLECTOR

1. BASE

3. EMITTER

2.

3 DIM MIN. MAX. 4.32 А 5.33 В 4.45 5.20 С 3.18 4.19 D 0.41 0.55 Е 0.35 0.50 F 5 DEG G 1.14 1.40 Н 1.14 1.53 Κ 12.70

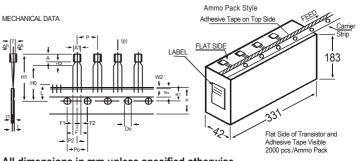
1.982

All diminsions in mm.

2.082

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1 2



TO-92 Transistors on Tape and Ammo Pack

All dimensions in mm unless specified otherwise

ITEM		SPECIFICATION			DEMADIKA	
TIEM	SYMBOL	MIN.	NOM.	MAX.	TOL .	REMARKS
BODY WIDTH BODY HEIGHT BODY THICKNESS	A1 A T	4.0 4.8 3.9		4.8 5.2 4.2		
PITCH OF COMPONENT FEED HOLE PITCH FEED HOLE CENTRE TO	P Po		12.7 12.7		±1 ±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS COMPONENT ALIGNMENT TAPE WIDTH HOLD-DOWN TAPE WIDTH HOLE POSITION	F △h Wo W1		5.08 0 18 6 9	1	+0.6 -0.2 ±0.5 ±0.2 +0.7 -0.5	AT TOP OF BODY
HOLD-DOWN TAPE POSITION LEAD WIRE CLINCH HEIGHT COMPONENT HEIGHT LENGTH OF SNIPPED LEADS FEED HOLE DIAMETER TOTAL TAPE THICKNESS LEAD - TO - LEAD DISTANCEF1,	W2 Ho H1 Do t F2		0.5 16 4 2.54	23.25 11.0 1.2	±0.2 ±0.5 ±0.2 +0.4 -0.1	t1 0.3 - 0.6
CLINCH HEIGHT PULL - OUT FORCE	H2 (P)	6N		3	-0.1	
NOTES						

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm. 2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.

PITCHES. 3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE. 4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED. 5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT. 6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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Disclaimer

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CD2383Rev030901